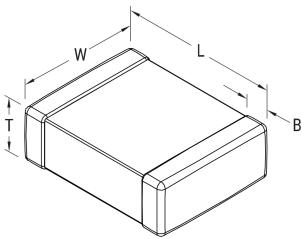


CBR08C360FAGAC

CBR-SMD RF COG, Ceramic, 36 pF, 1%, 250 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0805



Click here for the 3D model.

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
Т	0.85mm +/-0.1mm
В	0.5mm +/-0.2mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

CBR-SMD RF COG
SMD Chip
SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Ultra High Q, Low ESR, Class I
Yes
Tin
No
No
12.03 mg
Solder Wave or Solder Reflow.
78 Weeks
1

Specifications	
Capacitance	36 pF
Capacitance Tolerance	1%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Dissipation Factor	O.1%
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms
Quality Factor	1000

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